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100V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

V _{(BR)DSS}	R _{DS(on) max}	Ι _D T _A = +25°C
100V	220mΩ @ V _{GS} = 10V	2.3A
	$250m\Omega @ V_{GS} = 4.5V$	2.1A

Description

This new generation MOSFET is designed to minimize the on-state resistance ($R_{DS(ON)}$) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- DC-DC Converters
- Power Management Functions

Features and Benefits

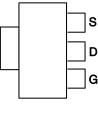
- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

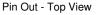
- Case: SOT223
- Case Material: Molded Plastic, "Green" Molding Compound; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Connections: See Diagram Below
- Terminals: Finish Matte Tin Annealed over Copper Leadframe; Solderable per MIL-STD-202, Method 208 (63)
- Weight: 0.112 grams (Approximate)

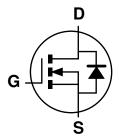


Top View



D





Equivalent Circuit

Ordering Information (Note 4)

Part Number	Compliance	Case	Packaging
DMN10H220LE-13	Standard	SOT223	2,500/Tape & Reel

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

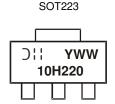
2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green"

and Lead-free. 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and

<1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



Diff = Manufacturer's Marking 10H220 = Marking Code YWW = Date Code Marking Y or \overline{Y} = Year (ex: 3 = 2013) WW = Week (01 - 53)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units	
Drain-Source Voltage		V _{DSS}	100	V
Gate-Source Voltage		V _{GSS}	±20	V
Continuous Drain Current (Note 5) V _{GS} = 10V	$T_{A} = +25^{\circ}C$ $T_{A} = +70^{\circ}C$	ID	2.3 1.8	А
	$T_{C} = +25^{\circ}C$ $T_{C} = +70^{\circ}C$	ID	6.2 4.9	A
Maximum Continuous Body Diode Forward Current (Note 5)		ls	1.5	А
Pulsed Drain Current (10µs pulse, duty cycle = 1%)		I _{DM}	8	А

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Units	
Total Power Dissipation (Note 5)	TA = +25°C	D	1.8	w	
Total Power Dissipation (Note 5)	TA = +70°C	PD	1.1	٧V	
Thermal Resistance, Junction to Ambient (Note 5)		$R_{ ext{ heta}JA}$	69	°C/W	
Total Power Dissipation (Note 5)	$Tc = +25^{\circ}C$	PD	14	W	
Thermal Resistance, Junction to Case (Note 5)		$R_{\theta JC}$	8.7	°C/W	
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C	

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 6)							
Drain-Source Breakdown Voltage	BV _{DSS}	100	—	—	V	$V_{GS} = 0V, I_D = 250 \mu A$	
Zero Gate Voltage Drain Current	I _{DSS}	_	—	1	μΑ	$V_{DS} = 100V, V_{GS} = 0V$	
Gate-Source Leakage	IGSS	_	—	±100	nA	$V_{GS} = \pm 16V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 6)			•	•	•	•	
Gate Threshold Voltage	V _{GS(th)}	1	1.7	2.5	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
Static Drain-Source On-Resistance	Р	_	155	220	mΩ	$V_{GS} = 10V, I_D = 1.6A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	190	250	11112	$V_{GS} = 4.5V, I_D = 1.3A$	
Diode Forward Voltage	V _{SD}	_	0.8	1.5	V	$V_{GS} = 0V, I_{S} = 1.1A$	
DYNAMIC CHARACTERISTICS (Note 7)			•	•	•	•	
Input Capacitance	Ciss	—	401	_		$V_{DS} = 25V, V_{GS} = 0V$ f = 1.0MHz	
Output Capacitance	Coss	_	22	—	pF		
Reverse Transfer Capacitance	Crss	_	17	—			
Gate Resistnace	Rg	_	2.1	—	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	4.1	—			
Total Gate Charge (V _{GS} = 10V)	Qg	_	8.3	_	nC	$V_{DS} = 50V, I_D = 1.6A$	
Gate-Source Charge	Q _{gs}	_	1.5	_	nc		
Gate-Drain Charge	Q _{gd}	_	2	_			
Turn-On Delay Time	t _{D(on)}	_	6.8	_		$V_{DS} = 50V, V_{GS} = 4.5V,$ $R_G = 6.8\Omega, I_D = 1.0A$	
Turn-On Rise Time	tr	_	8.2	_			
Turn-Off Delay Time	t _{D(off)}	_	7.9	—	ns		
Turn-Off Fall Time	t _f	_	3.6	—			
Reverse Recovery Time	t _{rr}	_	17	—	ns		
Reverse Recovery Charge	Q _{rr}	_	9.8	_	nC	—I _S = 1.1A, di/dt =100A/μs	

Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal vias to bottom layer 1-inch square copper plate.

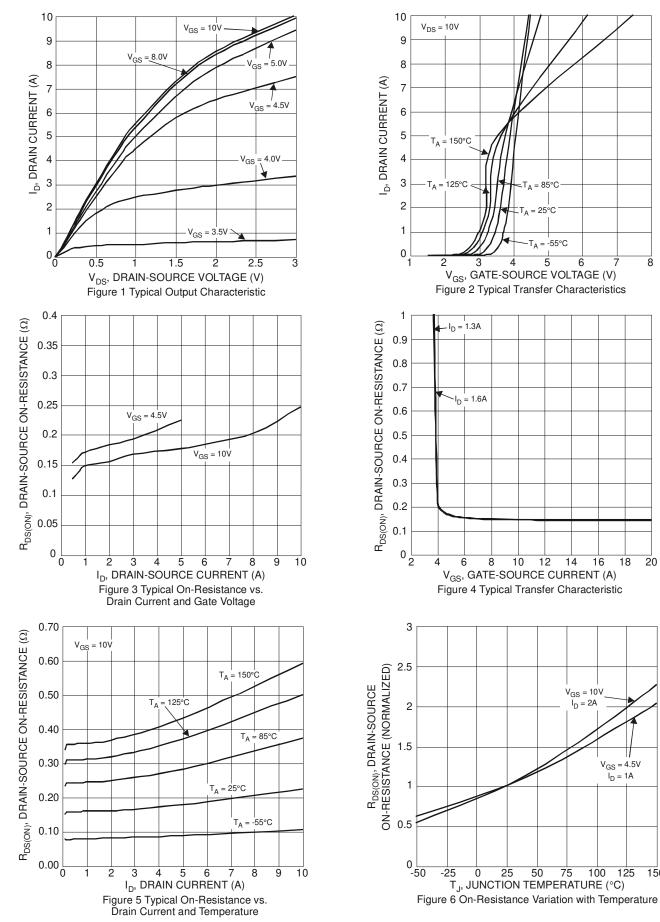
6 .Short duration pulse test used to minimize self-heating effect.

7. Guaranteed by design. Not subject to production testing.



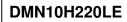
DMN10H220LE

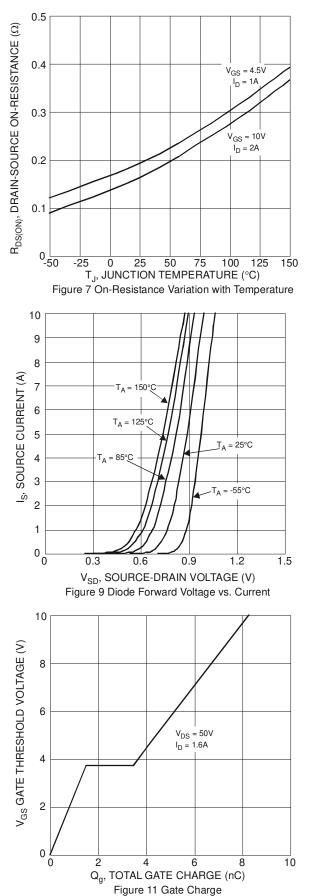
8



150







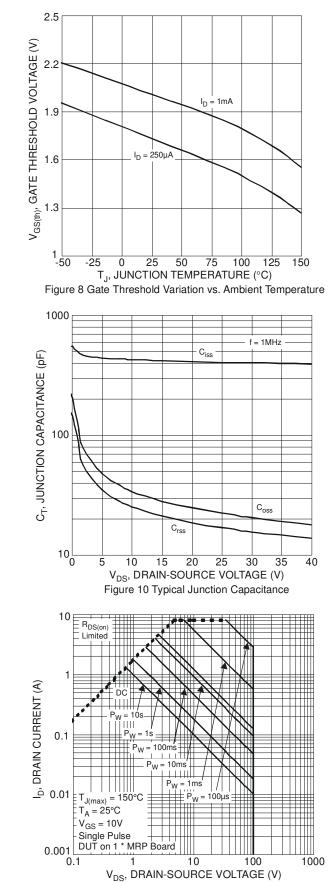
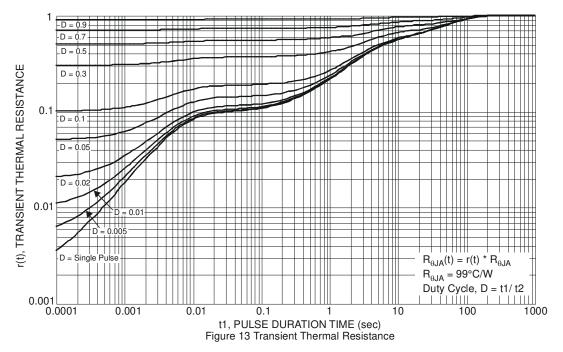


Figure 12 SOA, Safe Operation Area

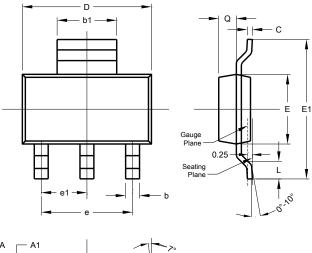


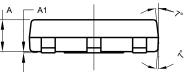




Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

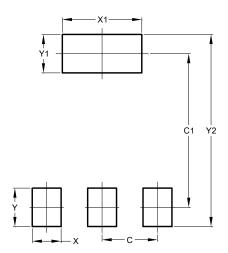




	SOT223				
Dim	Min	Max	Тур		
Α	1.55	1.65	1.60		
A1	0.010	0.15	0.05		
b	0.60	0.80	0.70		
b1	2.90	3.10	3.00		
С	0.20	0.30	0.25		
D	6.45	6.55	6.50		
Е	3.45	3.55	3.50		
E1	6.90	7.10	7.00		
e	-	-	4.60		
e1	-	-	2.30		
L	0.85	1.05	0.95		
Q	0.84	0.94	0.89		
All	All Dimensions in mm				

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	2.30
C1	6.40
Х	1.20
X1	3.30
Y	1.60
Y1	1.60
Y2	8.00



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